

Vishay Siliconix

N-Channel 8 V (D-S) MOSFET

PRODU	CT SUMMARY		
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)
	0.086 at V_{GS} = 4.5 V	1.34 ^a	
8	0.093 at V _{GS} = 2.5 V	1.29	7.1
0	0.102 at V _{GS} = 1.8 V	1.23	7.1
	0.120 at V _{GS} = 1.5 V	0.7	

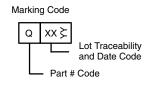
SC-89 (6-LEADS)

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

Load Switch for Portable Devices



Ordering Information: Si1050X-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATING	S (T _A = 25 °C, un	less otherwise r	noted)		
Parameter		Symbol	Limit	Unit	
Prain-Source Voltage		V _{DS}	8	V	
Gate-Source Voltage		V _{GS}	± 5	v	
	T _A = 25 °C		1.34 ^{b, c}		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C	D	1.07 ^{b, c}	A	
Pulsed Drain Current	· ·	I _{DM}	6		
Continuous Source-Drain Diode Current	T _A = 25 °C	ا _S	0.2 ^{b, c}		
	T _A = 25 °C	$T_A = 25 \degree C$ P_D $O.$		w	
Maximum Power Dissipation ^a	T _A = 70 °C	'D	0.151 ^{b, c}	vv	
Operating Junction and Storage Temperature Ra	ange	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum lumation to Anabianth d	t ≤ 5 s	R _{thJA}	440	530	°C/W
Maximum Junction-to-Ambient ^{b, d}	Steady State	' 'thJA	540	650	0/10

Notes:

a. Based on T_C = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 650 °C/W.

HALOGEN

Si1050X

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	8			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$			18.2		
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	l _D = 250 μA		- 2.55		mV/°0
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.35		0.9	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 5 V$			± 100	nA
	I _{DSS}	$V_{DS} = 8 V, V_{GS} = 0 V$			1	
Zero Gate Voltage Drain Current		$V_{DS} = 8 V, V_{GS} = 0 V, T_{J} = 85 °C$			10	μΑ
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = \ge 5 V, V_{GS} = 4.5 V$	6			Α
	_ ()	V _{GS} = 4.5 V, I _D = 1.34 A		0.071	0.086	-
	P	V _{GS} = 2.5 V, I _D = 1.29 A		0.078	0.093	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 1.8 V, I _D = 1.23 A		0.085	0.102	Ω
		V _{GS} = 1.5 V, I _D = 0.76 A		0.092	0.120	
Forward Transconductance	9 _{fs}	V _{DS} = 4 V, I _D = 1.34 A		4.12		S
Dynamic ^b	-					
Input Capacitance	C _{iss}			585		pF
Output Capacitance	C _{oss}	V _{DS} = 4 V, V _{GS} = 0 V, f = 1 MHz		190		
Reverse Transfer Capacitance	C _{rss}			130		
	Qg	V _{DS} = 4 V, V _{GS} = 5 V, I _D = 1.34 A		7.7	7.7 11.6	nC
Total Gate Charge				7.1	10.7	
Gate-Source Charge	Q _{gs}	V _{DS} = 4 V, V _{GS} = 4.5 V, I _D = 1.34 A		1.14		
Gate-Drain Charge	Q _{gd}			1.69		
Gate Resistance	R _a	f = 1 MHz		3.5	4.6	Ω
Turn-On Delay Time	t _{d(on)}			6.8	10.2	
Rise Time	t _r	$V_{DD} = 4 V, R_1 = 3.6 \Omega$		35	53	- ns
Turn-Off DelayTime	t _{d(off)}	$I_D \cong 1.1 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_q = 1 \Omega$		25	37.5	
Fall Time	t _f			6	9	
Drain-Source Body Diode Characterist	ics					1
Pulse Diode Forward Current ^a	I _{SM}				6	А
Body Diode Voltage	V _{SD}	I _S = 1.0 A	1	0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}	~	1	18.5	28	nC
Body Diode Reverse Recovery Charge	Q _{rr}			3.7	5.7	
Reverse Recovery Fall Time	t _a	— I _F = 1.0 A, dl/dt = 100 A/μs		6.7		ns
Reverse Recovery Rise Time	t _b			11.8		

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

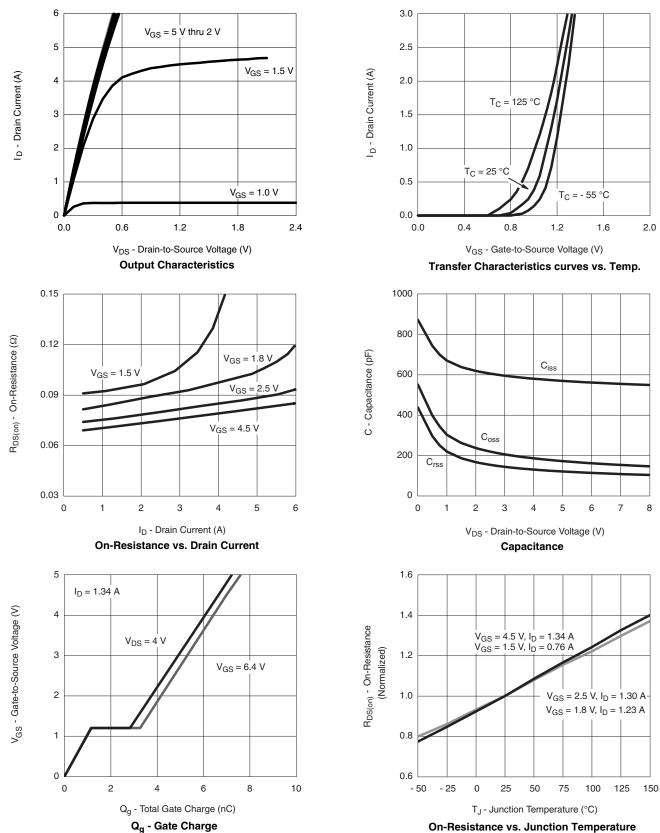
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



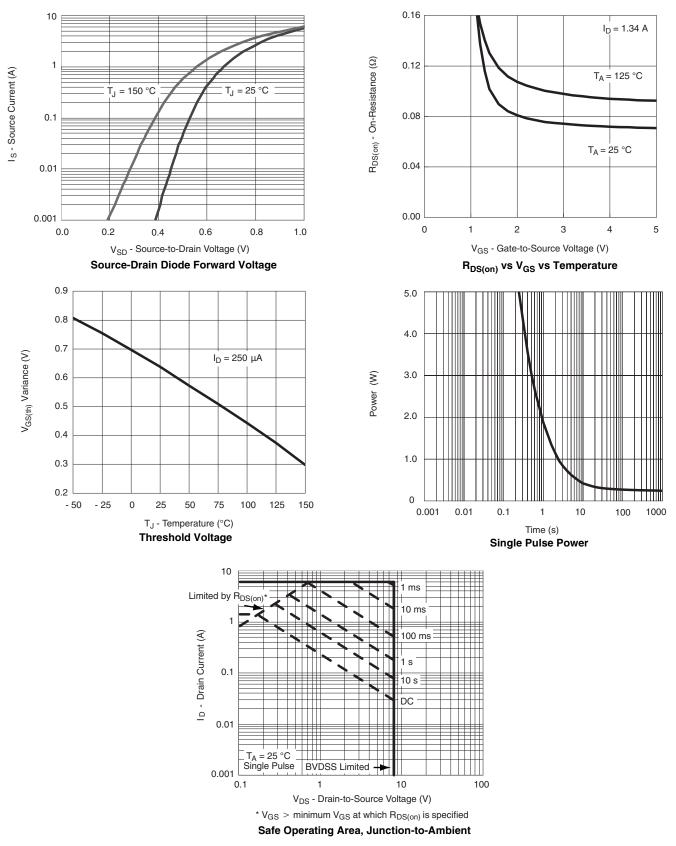
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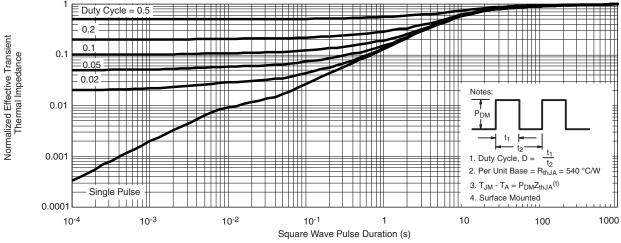


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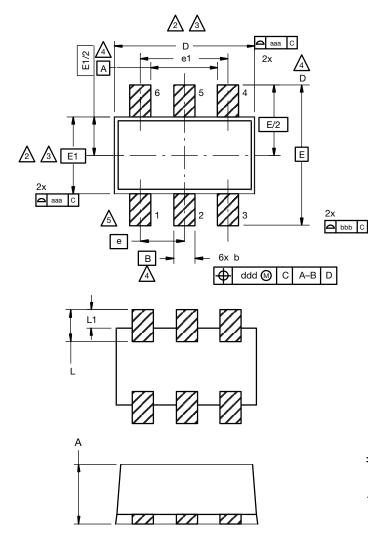
Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?73896</u>.



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SC-89 6-Leads (SOT-563F)



Notes

- 1. Dimensions in millimeters.
- Dimension D does not include mold flash, protrusions or gate burrs. Mold flush, protrusions or gate burrs shall not exceed 0.15 mm per dimension E1 does not include interlead flash or protrusion, interlead flash or protrusion shall not exceed 0.15 mm per side.
- A Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, the bar burrs, gate burrs and interlead flash, but including any mismatch between the top and the bottom of the plastic body.

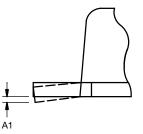
 \underline{A} Datums A, B and D to be determined 0.10 mm from the lead tip.

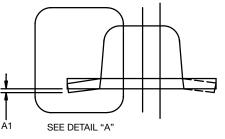
A Terminal numbers are shown for reference only.

A These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.









DIM.	MILLIMETERS			
	MIN.	NOM.	MAX.	
А	0.56	0.58	0.60	
A1	0	0.02	0.10	
b	0.15	0.22	0.30	
С	0.10	0.14	0.18	
D	1.50	1.60	1.70	
E	1.50	1.60	1.70	
E1	1.15	1.20	1.25	
е	0.45	0.50	0.55	
e1	0.95	1.00	1.05	
L	0.25	0.35	0.50	
L1	0.10	0.20	0.30	
C14-0439-Rev DWG: 5880	/. C, 11-Aug-14			

Revision: 11-Aug-14

1 For technical questions, contact: analogswitchtechsupport@vishay.com Document Number: 71612

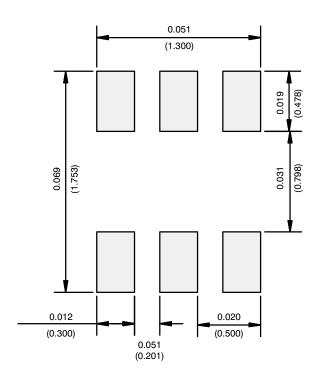
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Application Note 826

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RECOMMENDED MINIMUM PADS FOR SC-89: 6-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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